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CONFIRMATION NO. APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. 10/25/2003 AM-5209.D2 1973 10/693,775 Ling Chen **EXAMINER** 04/29/2004 7590 Applied Materials, Inc. NGUYEN, TUAN H Patent / Legal Dept. PAPER NUMBER ART UNIT M/S 2061 P.O. Box 450A 2813 Santa Clara, CA 95052

DATE MAILED: 04/29/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	
			CHEN ET AL.	
Office Action Summary		10/693,775		<del></del>
		Examiner	Art Unit	
	The MAILING DATE of this communica	Tuan H. Nguyen	2813	dross
Period fo		mon app ars on the cover sheet	with the correspondence at	iuress
THE - Exte after - If the - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR MAILING DATE OF THIS COMMUNICA nasions of time may be available under the provisions of 3 SIX (6) MONTHS from the mailing date of this communication of the period for reply specified above is less than thirty (30) of period for reply is specified above, the maximum statution to reply within the set or extended period for reply will reply received by the Office later than three months after ed patent term adjustment. See 37 CFR 1.704(b).	ATION.  7 CFR 1.136(a). In no event, however, may cation.  ays, a reply within the statutory minimum of tory period will apply and will expire SIX (6) Mo, by statute, cause the application to become	a reply be timely filed hirty (30) days will be considered timel ONTHS from the mailing date of this c ABANDONED (35 U.S.C. § 133).	ly. :ommunication.
Status				
1)⊠	Responsive to communication(s) filed	on <u>25 October 2003</u> .		
•	•	☐ This action is non-final.		
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.			
Disposit	ion of Claims	•		
4)⊠ 5)□ 6)⊠ 7)□	4) Claim(s) 1-16 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration.  5) Claim(s) is/are allowed.  6) Claim(s) 1-16 is/are rejected.  7) Claim(s) is/are objected to.  8) Claim(s) are subject to restriction and/or election requirement.			
Applicat	ion Papers			
9) The specification is objected to by the Examiner.				
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.				
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).				
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).  11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.				
Priority (	under 35 U.S.C. § 119			
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>				
Attachmen		_		
	ce of References Cited (PTO-892)		w Summary (PTO-413) o(s)/Mail Date	
3) 🛛 Infor	ce of Draftsperson's Patent Drawing Review (PTC mation Disclosure Statement(s) (PTO-1449 or PT er No(s)/Mail Date <u>1/22/04</u> .	- · · · /	f Informal Patent Application (PT	O-152)

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## Double Patenting

The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. See *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re Vogel*, 422 F.2d 438, 164 USPQ 619 (CCPA 1970);and, *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent is shown to be commonly owned with this application. See 37 CFR 1.130(b).

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

Claims 1-16 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-31 of U.S. Patent No. 6,498,091. Although the conflicting claims are not identical, they are not patentably distinct from each other because they are both directed to a method for forming a copper interconnect including the step of sputter-etching the first barrier layer, and depositing a second barrier layer. See claims 1, 7, 8 of U.S. Pat. No. 6,498,091 for the steps of coating the hole with first barrier layer, sputtering the first barrier layer from the bottom of the hole, depositing a second barrier layer, depositing a copper seed layer, and electroplating the hole with copper. The use ALD for depositing the first barrier layer, and PVD for the seed layer are well-known and considered obvious to those skilled in the art.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) and the Intellectual Property and High Technology Technical Amendments Act of 2002 do not apply when the reference is a U.S. patent resulting directly or indirectly from an international application filed before November 29, 2000. Therefore, the prior art date of the reference is determined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

Claims 1-3 are rejected under 35 U.S.C. 102(e) as being anticipated by Sata et al..

See Sata et al., figs. 1-4 and related text on col. 1-13 which discloses the claimed method for forming a copper interconnect including the steps of depositing a barrier layer 26 of TaN by ALD on sides of the hole (fig. 2, col. 7, next to bottom paragraph); depositing a copper seed layer by PVD; electroplating copper 18 into the hole over the copper seed layer (col. 13, lines 38-52).

With respect to claim 3, see col. 13, lines 30-34.

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The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Lopatine et al., and Cohen are cited as of interest.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tuan H. Nguyen whose telephone number is 571-272-1694. The examiner can normally be reached on 9AM-5:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead Jr. can be reached on 571-272-1702. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Tuan H. Nguyen Primary Examiner Art Unit 2813